PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name		Execution Date	
Takayuki HASHIMOTO		02/01/2011	

RECEIVING PARTY DATA

Name:	RENESAS ELECTRONICS CORPORATION	
Street Address:	1753, Shimonumabe, Nakahara-ku, Kawasaki-shi	
City:	Kanagawa	
State/Country:	JAPAN	
Postal Code:	211-8668	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13048938

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	T&A-7764
NAME OF SUBMITTER:	Shrinath Malur

Total Attachments: 1

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PATENT REEL: 025964 FRAME: 0346 CH \$40.00 15048

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Electronics Corporation, a corporation organized under the laws of Japan,

located at 1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa 211-8668, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Electronics Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR SUBSTRATE AND SEMICONDUCTOR CHIP

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Electronics Corporation,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Electronics Corporation.

Signed on the date(s) indicated aside our signatures:

	INVENTOR(S) (発明者フルネームサイン)		Date Signed (署名日)			
1)	Takayuhi Kashimoto (Takayuki HAS	sнімото)_	2/1/2	2011		
2)						
3)						
4)						
5)				· .		
6)						

PATENT

REEL: 025964 FRAME: 0347 RECORDED: 03/16/2011